



June 1, 1999

PCN # 992201

# Notice of Obsolescence

## 1Mb SRAM 300-mil PDIP package

To: Alliance Sales Representatives, Distributors, and Customers

Alliance is formally discontinuing production of the 300-mil 32-pin plastic "skinny" DIP package. The following part numbers are affected:

AS7C1024-15/20/25TPC

AS7C31024-15/20/25TPC

Other package types still available for this product are SOJ (300 and 400-mil) and TSOP.

Obsolescence of the 300-mil PDIP package reflects evolutionary capacity shifts to alternative packaging for SRAM products. Expected market demand does not justify continuation of this package type for 1M SRAM products.

Customers are encouraged to qualify alternate sources at their earliest convenience. Alternate sources for this product are Cypress, ISSI, NEC, Hitachi, Mitsubishi, and Sony. It is not known to what extent these vendors may still be in production on these devices.

Inquiries regarding product availability, pricing, policy and other issues should be forwarded the local sales representative or Alliance office.

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